# DATA SHEET

### **CBTS3384**

10-bit bus switch with 5-bit output enables and Schottky undershoot protection

Product data Supersedes data of 2001 Feb 13





## 10-bit bus switch with 5-bit output enables and Schottky undershoot protection

**CBTS3384** 

#### **FEATURES**

- ullet 5  $\Omega$  switch connection between two ports
- TTL compatible control input and output levels
- Undershoot protection included to prevent shoot through level changes
- Latch-up protection exceeds 500 mA per JESD78
- ESD protection exceeds 2000 V HBM per JESD22-A114, 200 V MM per JESD22-A115 and 1000 V CDM per JESD22-C101

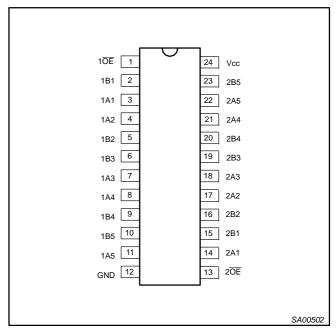
#### **DESCRIPTION**

The CBTS3384 provides ten bits of high-speed TTL-compatible bus switching. The low on-state resistance of the switch allows connections to be made with minimal propagation delay.

The CBTS3384 device is organized as two 5-bit bus switches with separate output-enable ( $\overline{\text{OE}}$ ) inputs. When  $\overline{\text{OE}}$  is LOW, the switch is on and port A is connected to B. When  $\overline{\text{OE}}$  is HIGH, the switch is open and high-impedance state exists between the two ports.

The CBTS3384 is characterized for operation from -40 to +85  $^{\circ}\text{C}.$ 

#### **PIN CONFIGURATION**



#### **PIN DESCRIPTION**

· 2 _ 3 3	_	_
PIN NUMBER	SYMBOL	NAME AND FUNCTION
1, 13	1 <del>0E</del> , 2 <del>0E</del>	Output enables
3, 4, 7, 8, 11	1A1-1A5	Inputs
14, 17, 18, 21, 22	2A1-2A5	Inputs
2, 5, 6, 9, 10	1B1-1B5	Outputs
15, 16, 19, 20, 23	2B1-2B5	Outputs
12	GND	Ground (0 V)
24	V <sub>CC</sub>	Positive supply voltage

#### **QUICK REFERENCE DATA**

SYMBOL	PARAMETER	CONDITIONS T <sub>amb</sub> = 25 °C; GND = 0 V	TYPICAL	UNIT
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation delay An to Yn	$C_L = 50 \text{ pF}; V_{CC} = 5 \text{ V}$	250	ps
C <sub>IN</sub>	Input capacitance	$V_I = 0 \text{ V or } V_{CC}$	4	pF
C <sub>OUT</sub>	Output capacitance	Outputs disabled; $V_O = 0 \text{ V or } V_{CC}$	10	pF
I <sub>CCZ</sub>	Total supply current	Outputs disabled; V <sub>CC</sub> = 5.5 V	3	μΑ

#### ORDERING INFORMATION

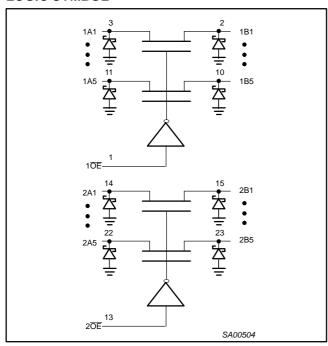
PACKAGES	TEMPERATURE RANGE	ORDER CODE	DWG NUMBER
24-Pin Plastic SO	-40 to +85 °C	CBTS3384D	SOT137-1
24-Pin Plastic SSOP	-40 to +85 °C	CBTS3384DB	SOT340-1
24-Pin Plastic SSOP (QSOP)	-40 to +85 °C	CBTS3384DK	SOT556-1
24-Pin Plastic TSSOP	-40 to +85 °C	CBTS3384PW	SOT355-1

Standard packing quantities and other packaging data is available at www.philipslogic.com/packaging.

## 10-bit bus switch with 5-bit output enables and Schottky undershoot protection

**CBTS3384** 

#### **LOGIC SYMBOL**



#### **FUNCTION TABLE**

INP	UTS	OUTPUTS					
1 <del>OE</del>	2 <del>0E</del>	1A, 1B	2A, 2B				
L	L	1A = 1B	2A= 2B				
L	Н	1A = 1B	Z				
Н	L	Z	2A = 2B				
Н	Н	Z	Z				

H = High voltage level

L = Low voltage level

Z = High impedance "off" state

#### ABSOLUTE MAXIMUM RATINGS<sup>1, 2</sup>

SYMBOL	PARAMETER	CONDITIONS	RATING	UNIT
V <sub>CC</sub>	DC supply voltage		-0.5 to +7.0	V
I <sub>IK</sub>	DC input diode current		-50	mA
V <sub>I</sub>	DC input voltage <sup>3</sup>		-1.2 to +7.0	V
I <sub>SW</sub>	DC output diode current	V <sub>O</sub> < 0	±128	mA
T <sub>stg</sub>	Storage temperature range		-65 to +150	°C

#### NOTES

- Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the
  device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to
  absolute-maximum-rated conditions for extended periods may affect device reliability.
- 2. The performance capability of a high-performance integrated circuit in conjunction with its thermal environment can create junction temperatures which are detrimental to reliability. The maximum junction temperature of this integrated circuit should not exceed 150°C.
- 3. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

#### RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER	LIM	UNIT	
STWIBUL	PARAMETER	Min	Max	UNII
V <sub>CC</sub>	DC supply voltage	4.5	5.5	V
$V_{IH}$	High-level input voltage	2.0		V
$V_{IL}$	Low-level Input voltage		0.8	V
T <sub>amb</sub>	Operating free-air temperature range	-40	+85	°C

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#### DC ELECTRICAL CHARACTERISTICS

				LIMITS		
SYMBOL	PARAMETER	TEST CONDITIONS	T <sub>amb</sub> :	= -40 to -	⊦85 °C	UNIT
			Min	Typ <sup>1</sup>	Max	
$V_{IK}$	Input clamp voltage	$V_{CC} = 4.5 \text{ V}; I_{I} = -18 \text{ mA}$	_	_	-1.2	V
II	Input leakage current	V <sub>CC</sub> = 5.5 V; V <sub>I</sub> = GND or 5.5 V	_	_	±1	μΑ
I <sub>CC</sub>	Quiescent supply current <sup>2</sup>	$V_{CC} = 5.5 \text{ V}; I_{O} = 0, V_{I} = V_{CC} \text{ or GND}$	_	_	3	μΑ
$\Delta I_{CC}$	Additional supply current per input pin <sup>2</sup>	$V_{CC}$ = 5.5 V, one input at 3.4 V, other inputs at $V_{CC}$ or GND	_	_	2.5	mA
C <sub>I</sub>	Control pins	V <sub>I</sub> = 3.0 V or 0	_	4	_	pF
C <sub>I(OFF)</sub>	Power-off leakage current	$V_O = 3.0 \text{ V or } 0, \overline{OE} = V_{CC}$	_	10	_	pF
		V <sub>CC</sub> = 4.5 V; V <sub>I</sub> = 0 V; I <sub>I</sub> = 64 mA	_	5	7	
$r_{on}^3$	On-resistance	$V_{CC} = 4.5 \text{ V}; V_I = 0 \text{ V}; I_I = 30 \text{ mA}$	_	5	7	Ω
		$V_{CC} = 4.5 \text{ V}; V_I = 2.4 \text{ V}; I_I = -15 \text{ mA}$	_	10	15	
$V_{P}$	Pass voltage	$V_{I}=V_{CC}=5.0 \text{ V}; I_{O}=-100 \mu\text{A}$	3.4	3.6	3.9	V
I <sub>UCP</sub>	Undershoot static current protection	$V_{CC}$ = 5.0 V, $I_B$ = 400 $\mu$ A; $\overline{OE}$ = 5.0 V; $V_B \ge 3.0$ V		8	_	mA

#### NOTES:

- 1. All typical values are at  $V_{CC} = 5 \text{ V}$ ,  $T_{amb} = 25 ^{\circ}\text{C}$ .
- 2. This is the increase in supply current for each input that is at the specified TTL voltage level rather than V<sub>CC</sub> or GND.
- 3. Measured by the voltage drop between the A and the B terminals at the indicated current through the switch. On-state resistance is determined by the lowest voltage of the two (A or B) terminals.

#### **AC CHARACTERISTICS**

 $GND = 0 V; t_{R;} C_{L} = 50 pF$ 

				LIM	ITS		
SYMBOL	PARAMETER	FROM (INPUT)	TO (OUTPUT)	$V_{CC} = +5.0$	UNIT		
		( 01)	(6611 61)	Min	Max		
t <sub>pd</sub>	Propagation delay <sup>1</sup>	A or B	B or A		0.25	ns	
t <sub>en</sub>	Output enable time to High and Low level	ŌĒ	A or B	1.0	5.7	ns	
t <sub>dis</sub>	Output disable time from High and Low level	ŌĒ	A or B	1.0	5.2	ns	

#### NOTE:

1. This parameter is warranted but not production tested. The propagation delay is based on the RC time constant of the typical on-state resistance of the switch and a load capacitance of 50 pF, when driven by an ideal voltage source (zero output impedance).

SYMBOL	PARAMETER DESCRIPTION	,	UNIT			
		MIN.	MEAN	MAX.		
t <sub>PD</sub>	Propagation delay (see Note 1)	_	_	250	pS	
t <sub>PZH</sub>	Output enable time to High level	1.6	3.4	5.6	nS	
t <sub>PHZ</sub>	Output enable time from High level	1.7	3.3	5.5	nS	
t <sub>PZL</sub>	Output enable time to Low level	2.3	4	6	nS	
$t_{PLZ}$	Output enable time from Low level	2.5	4.5	6.6	nS	

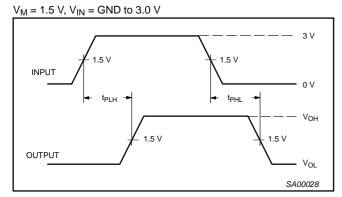
#### NOTE:

1. This parameter is warranted but not production tested. The propagation delay is based on the RC time constant of the typical on-state resistance of the switch and a load capacitance of 50 pF, when driven by an ideal voltage source (zero output impedance); at +25 °C.

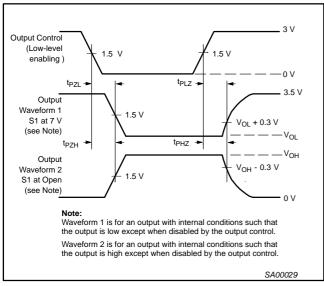
## 10-bit bus switch with 5-bit output enables and Schottky undershoot protection

**CBTS3384** 

#### **AC WAVEFORMS**

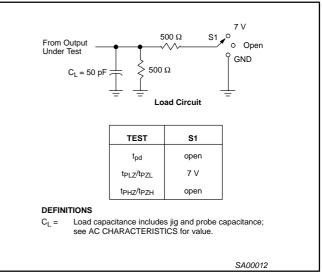


Waveform 1. Input (An) to Output (Yn) Propagation Delays



Waveform 2. 3-State Output Enable and Disable Times

#### **TEST CIRCUIT AND WAVEFORMS**



#### NOTES:

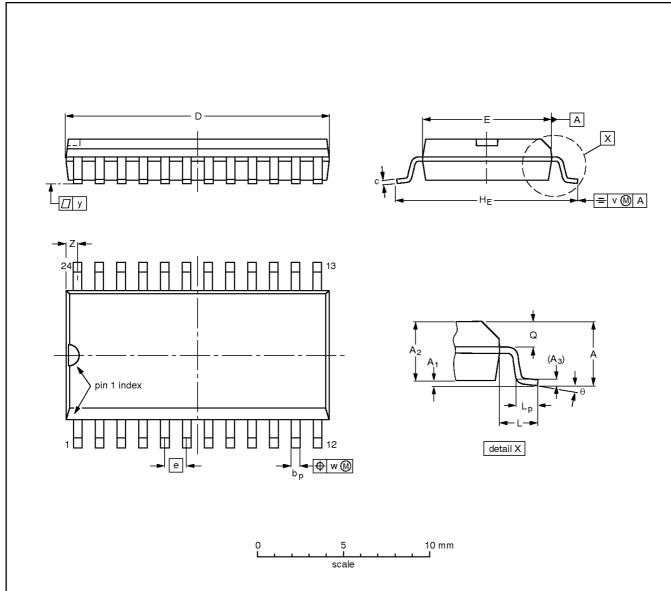
- 1. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz,  $Z_O=50~\Omega$ ,  $t_f\leq 2.5$  ns,  $t_f\leq 2.5$  ns.
- The outputs are measured one at a time with one transition per measurement.

# 10-bit bus switch with 5-bit output enables and Schottky undershoot protection

**CBTS3384** 

#### SO24: plastic small outline package; 24 leads; body width 7.5 mm

SOT137-1



#### DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A <sub>1</sub>	A <sub>2</sub>	А3	bр	С	D <sup>(1)</sup>	E <sup>(1)</sup>	е	HE	L	Lp	Q	٧	w	у	z <sup>(1)</sup>	θ
mm	2.65	0.30 0.10	2.45 2.25	0.25	0.49 0.36	0.32 0.23	15.6 15.2	7.6 7.4	1.27	10.65 10.00	1.4	1.1 0.4	1.1 1.0	0.25	0.25	0.1	0.9 0.4	8°
inches	0.10	0.012 0.004	0.096 0.089	0.01	0.019 0.014	0.013 0.009	0.61 0.60	0.30 0.29	0.050	0.419 0.394	0.055	0.043 0.016		0.01	0.01	0.004	0.035 0.016	0°

#### Note

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

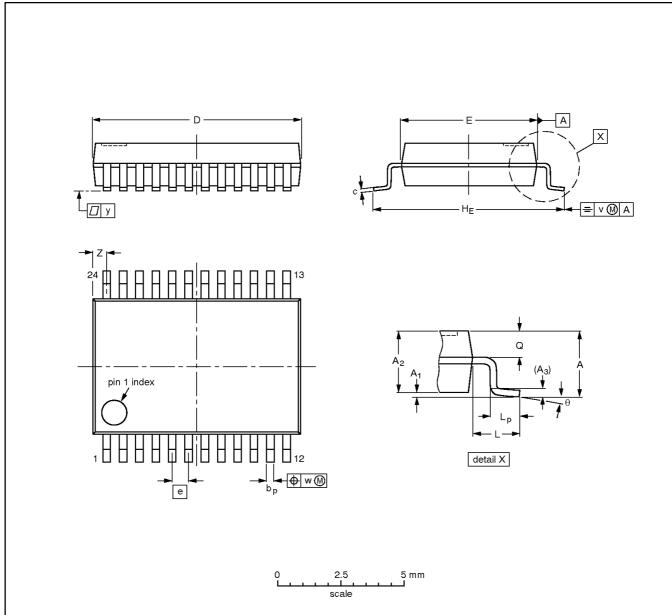
OUTLINE		REFER	EUROPEAN	ISSUE DATE			
VERSION	IEC	JEDEC	EIAJ		PROJECTION	155UE DATE	
SOT137-1	075E05	MS-013				<del>-97-05-22</del> 99-12-27	

# 10-bit bus switch with 5-bit output enables and Schottky undershoot protection

**CBTS3384** 

SSOP24: plastic shrink small outline package; 24 leads; body width 5.3 mm

SOT340-1



#### DIMENSIONS (mm are the original dimensions)

UNIT	A max.	A <sub>1</sub>	A <sub>2</sub>	А3	bp	c	D <sup>(1)</sup>	E <sup>(1)</sup>	е	HE	L	Lp	Q	v	w	у	Z <sup>(1)</sup>	θ
mm	2.0	0.21 0.05	1.80 1.65	0.25	0.38 0.25	0.20 0.09	8.4 8.0	5.4 5.2	0.65	7.9 7.6	1.25	1.03 0.63	0.9 0.7	0.2	0.13	0.1	0.8 0.4	8° 0°

#### Note

1. Plastic or metal protrusions of 0.20 mm maximum per side are not included.

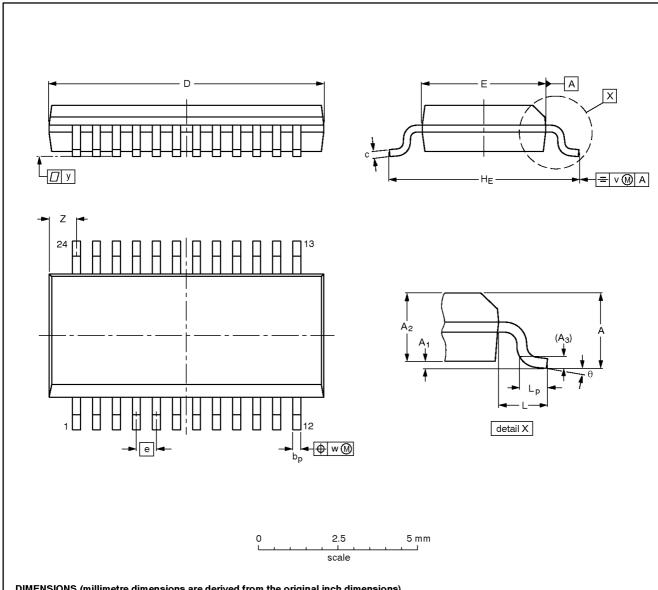
OUTLINE		REFER	EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE
SOT340-1		MO-150				<del>-95-02-04-</del> 99-12-27

### 10-bit bus switch with 5-bit output enables and Schottky undershoot protection

**CBTS3384** 

SSOP24: plastic shrink small outline package; 24 leads; body width 3.9 mm; lead pitch 0.635 mm

SOT556-1



#### DIMENSIONS (millimetre dimensions are derived from the original inch dimensions)

UNIT	A max.	A <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	ь <sub>р</sub>	С	D <sup>(1)</sup>	E <sup>(1)</sup>	е	HE	L	Lp	٧	w	у	Z <sup>(1)</sup>	θ
mm	1.73	0.25 0.10	1.55 1.40	0.25	0.31 0.20	0.25 0.18	8.8 8.6	4.0 3.8	0.635	6.2 5.8	1.0	0.89 0.41	0.25	0.18	0.1	1.05 0.66	8° 0°
inches	0.068	0.0098 0.0040		0.010		0.0098 0.0075		0.157 0.150	0.025	0.244 0.228	0.041	0.035 0.016	0.010	0.007	0.004	0.040 0.026	8° 0°

1. Plastic or metal protrusions of 0.20 mm maximum per side are not included.

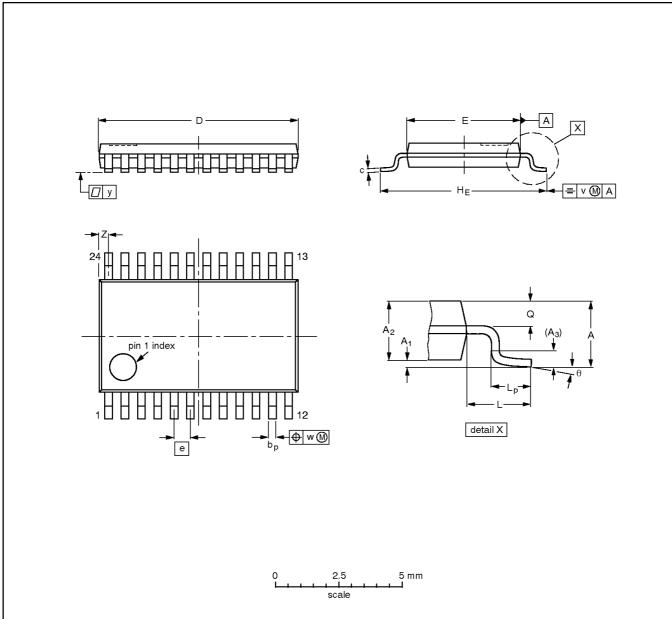
OUTLINE		REFER	EUROPEAN	ISSUE DATE			
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE	
SOT556-1		MO-137				<del>99-05-05</del> 99-12-27	

# 10-bit bus switch with 5-bit output enables and Schottky undershoot protection

**CBTS3384** 

TSSOP24: plastic thin shrink small outline package; 24 leads; body width 4.4 mm

SOT355-1



#### **DIMENSIONS (mm are the original dimensions)**

				9			-,												
ı	UNIT	A max.	A <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	bp	С	D <sup>(1)</sup>	E <sup>(2)</sup>	е	HE	L	Lp	Q	v	w	у	Z <sup>(1)</sup>	θ
	mm	1.10	0.15 0.05	0.95 0.80	0.25	0.30 0.19	0.2 0.1	7.9 7.7	4.5 4.3	0.65	6.6 6.2	1.0	0.75 0.50	0.4 0.3	0.2	0.13	0.1	0.5 0.2	8° 0°

#### Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE			
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE	
SOT355-1		MO-153				<del>-95-02-04</del> 99-12-27	

# 10-bit bus switch with 5-bit output enables and Schottky undershoot protection

**CBTS3384** 

#### **REVISION HISTORY**

Rev	Date	Description
_2	20021213	Product data (9397 750 09249); ECN 853-2238 27501 of 20 December 2001.
		Modifications:
		New package release.
_1	20010213	Product data (9397 750 08073); ECN 853-2238 25635 of 13 February 2001.

### 10-bit bus switch with 5-bit output enables and Schottky undershoot protection

**CBTS3384** 

#### Data sheet status

Level	Data sheet status <sup>[1]</sup>	Product status <sup>[2] [3]</sup>	Definitions
1	Objective data	Development	This data sheet contains data from the objective specification for product development.  Philips Semiconductors reserves the right to change the specification in any manner without notice.
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<sup>[3]</sup> For data sheets describing multiple type numbers, the highest-level product status determines the data sheet status.